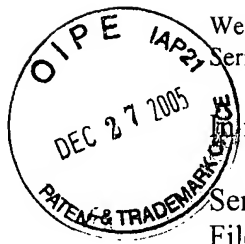


IFW



Western Digital Technologies, Inc.

Serial Number: 10/698,713

1

Patent

Docket: K35A1314

Inventor Application of:

Yih-Jen Dennis Chen

Serial No.: 10/698,713

Filed: 10/31/03

Title: HEAD STACK ASSEMBLY COMPRISING A
MULTI-LEVEL SHIPPING COMB TO
FACILITATE MERGING HEADS WITH
DISKS

Group Art Unit: 2652

Examiner: Davis, D. D.

RESPONSE TO OFFICE ACTION

THE COMMISSIONER FOR PATENTS
ALEXANDRIA, VA 22313

Dear Sir,

In response to an office action mailed on 06/29/05 for the above-identified patent application (a petition for a three month extension is filed herewith), please enter the following amendments to the specification and claims and consider the following remarks: